COMPONENTS MARKED ‘DNP’ SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: PMP40260</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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PLOT NAME = Top Assembly Drawing
GENERATED: 11/8/2017 11:25:08 AM
TEXAS INSTRUMENTS
Components marked 'DNP' should not be populated.
Assembly variant: 001

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<td>Plot name</td>
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